

SURFACE MOUNT

SILICON SCHOTTKY DIODES

Central Semiconductor Corp.

www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CBAT54 Series types are Silicon Schottky Diodes in an SOT-23 Surface Mount Package.



CBAT54:	SINGLE	MARKING CODE: CL4
CBAT54A:	DUAL, COMMON ANODE	MARKING CODE: CL42
CBAT54C:	DUAL, COMMON CATHODE	MARKING CODE: CL43
CBAT54S:	DUAL, IN SERIES	MARKING CODE: CL44

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	V _R	30	V
Continuous Forward Current	١ _F	200	mA
Peak Repetitive Forward Current	IFRM	300	mA
Forward Surge Current, tp=10ms	IFSM	600	mA
Power Dissipation	PD	350	mW
Operating and Storage Junction Temperature	TJ, Tstg	-65 to +150	°C
Thermal Resistance	Θ_{JA}	357	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	С мах	UNITS
I _R	V _R =25V	2.0	μA
VF	I _F =0.1mA	240	mV
V _F	I _F =1.0mA	320	mV
VF	I _F =10mA	400	mV
VF	I _F =30mA	500	mV
V _F	I _F =100mA	800	mV
Cd	V _R =1.0V, f=1.0MHz	10	pF
t _{rr}	I _F =I _R =10mA, I _{rr} =1.0mA, R _L =100Ω	5.0	ns

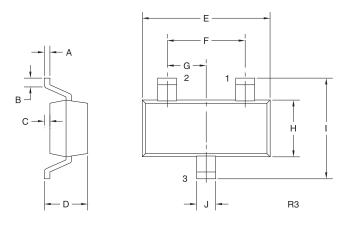
R1 (20-November 2009)





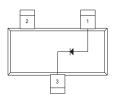
SURFACE MOUNT SILICON SCHOTTKY DIODES

SOT-23 CASE - MECHANICAL OUTLINE



DIMENSIONS								
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
А	0.003	0.007	0.08	0.18				
В	0.006	-	0.15	-				
С	-	0.005	-	0.13				
D	0.035	0.043	0.89	1.09				
E	0.110	0.120	2.80	3.05				
F	0.075		1.90					
G	0.037		0.95					
Н	0.047	0.055	1.19	1.40				
	0.083	0.098	2.10	2.49				
J	0.014	0.020	0.35	0.50				

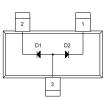
SOT-23 (REV: R3)



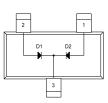
LEAD CODE: CBAT54

Anode
 No Connection
 Cathode

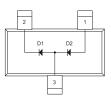
MARKING CODE: CL4



LEAD CODE: CBAT54A 1) Cathode D2 2) Cathode D1 3) Anode D1, Anode D2 MARKING CODE: CL42



LEAD CODE: CBAT54C 1) Anode D2 2) Anode D1 3) Cathode D1, Cathode D2 MARKING CODE: CL43



LEAD CODE:

CBAT54S 1) Anode D2 2) Cathode D1 3) Anode D1, Cathode D2 MARKING CODE: CL44

R1 (20-November 2009)

www.centralsemi.com

www.centralsemi.com

OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

Custom bar coding for shipments Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA Main Tel: (631) 435-1110 Main Fax: (631) 435-1824 Support Team Fax: (631) 435-3388 www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

Worldwide Distributors: www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: <u>www.centralsemi.com/terms</u>





单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达尔科技)